

1Mx8 Static RAM CMOS, Module

FEATURES

- 1024Kx8 bit CMOS Static
- Random Access Memory
 - Access Times 70 thru 100ns
 - Data Retention Function (EDI8F81024LP)
 - TTL Compatible Inputs and Outputs
 - Fully Static, No Clocks
- High Density Packaging
 - 36 Pin SIP, No. 62
- Single +5V ($\pm 10\%$) Supply Operation

*This product is subject to change without notice.

DESCRIPTION

The EDI8F81024C is a 8Mb CMOS Static RAM based on eight 128Kx8 Static RAMs mounted on a multi-layered epoxy laminate (FR4) substrate.

A version featuring Low Power with Data Retention (EDI8F81024LP) is also available.

The EDI8F81024C is offered in a double sided, 36 pin single-in-line Package (SIP). Surface mount SIP technology is a cost effective solution to very high packing density requirements.

All inputs and outputs are TTL compatible and operate from a single 5V supply. Fully asynchronous, the EDI8F81024C requires no clocks or refreshing for operation.

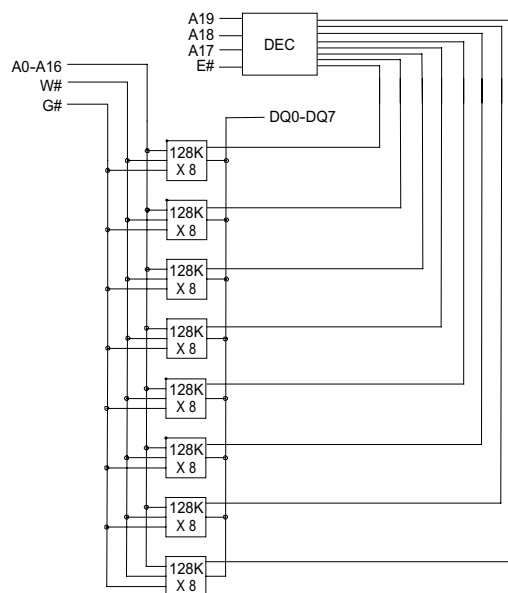
PIN CONFIGURATIONS AND BLOCK DIAGRAM

NC	1
Vcc	2
W#	3
DQ2	4
DQ3	5
DQ0	6
A1	7
A2	8
A3	9
A4	10
Vss	11
DQ5	12
A10	13
A11	14
A5	15
A13	16
A14	17
A19	18
E#	19
A15	20
A16	21
A12	22
A18	23
A6	24
DQ1	25
Vss	26
A0	27
A7	28
A8	29
A9	30
DQ7	31
DQ4	32
DQ6	33
A17	34
Vcc	35
G#	36

PIN OUT

PIN NAMES

A0-A19	Address Inputs
E#	Chip Enable
W#	Write Enable
G#	Output Enable
DQ0-DQ7	Common Data Input/Output
Vcc	Power (+5V $\pm 10\%$)
Vss	Ground
NC	No Connection



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ABSOLUTE MAXIMUM RATINGS*

Voltage on any pin relative to V _{SS}	-0.5V to 7.0V
Operating Temperature T _A (Ambient)	0°C to +70°C Commercial Industrial -40°C to +85°C
Storage Temperature	
Plastic	-55°C to +125°C
Power Dissipation	1 Watt
Output Current	20 mA

*Stress greater than those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions greater than those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect reliability.

RECOMMENDED DC OPERATING CONDITIONS

Parameter	Sym	Min	Typ	Max	Units
Supply Voltage	V _{CC}	4.5	5.0	5.5	V
Supply Voltage	V _{SS}	0	0	0	V
Input High Voltage	V _{IH}	2.2	-	6.0	V
Input Low Voltage	V _{IL}	-0.3	-	0.8	V

AC TEST CONDITIONS

Input Pulse Levels	V _{SS} to 3.0V
Input Rise and Fall Times	5ns
Input and Output Timing Levels	1.5V
Output Load	1TTL, CL = 100pF

(note: For TEHQZ, TGHQZ and TWLQZ, CL = 5pF)

DC ELECTRICAL CHARACTERISTICS

Parameter	Sym	Conditions		Min	Typ*	Max	Units
Operating Power Supply Current	I _{CC1}	W#, E# = V _{IL} , I/O = 0mA, Min Cycle			80	130	mA
Standby (TTL) Power Supply Current	I _{CC2}	E# ≥ V _{IH} , V _{IN} ≤ V _{IL} or V _{IN} ≥ V _{IH}			40	90	mA
Full Standby Power Supply Current (CMOS)	I _{CC3}	E# ≥ V _{CC} -0.2V V _{IN} ≥ V _{CC} -0.2V or V _{IN} ≤ 0.2V	C LP		10 400	20 950	mA μA
Input Leakage Current	I _{LI}	V _{IN} = 0V to V _{CC}		-	-	±10	μA
Output Leakage Current	I _{LO}	V I/O = 0V to V _{CC}		-	-	±10	μA
Output High Voltage	V _{OH}	I _{OH} = -1.0mA		2.4	-	-	V
Output Low Voltage	V _{OL}	I _{OL} = 2.1mA		-	-	0.4	V

*Typical: T_A = 25°C, V_{CC} = 5.0V

TRUTH TABLE

G#	E#	W#	Mode	Output	Power
X	H	X	Standby	HIGH Z	I _{CC2} /I _{CC3}
H	L	H	Output Deselect	HIGH Z	I _{CC1}
L	L	H	Read	D _{OUT}	I _{CC1}
X	L	L	Write	D _{IN}	I _{CC1}

CAPACITANCE

(f=1.0MHz, V_{IN}=V_{CC} or V_{SS})

Parameter	Sym	Max	Unit
Input Capacitance (Except DQ Pins)	C _I	58	pF
Capacitance (DQ Pins)	CD/Q	43	pF
Input (E#) Control Lines	CC	10	pF
Input (W#) Line (G#)	CW	60	pF

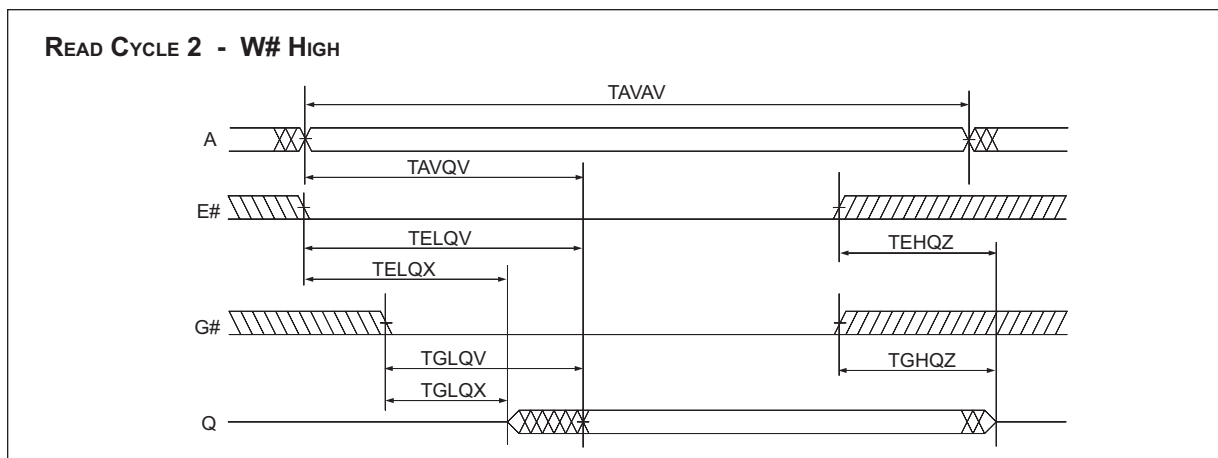
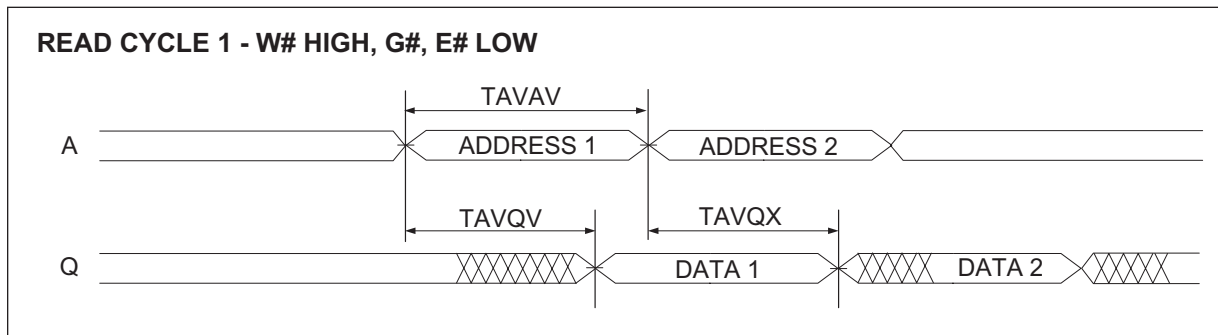
These parameters are sampled, not 100% tested.



AC CHARACTERISTICS READ CYCLE

Parameter	Symbol		70ns		85ns		100ns		Units
	JEDEC	Alt.	Min	Max	Min	Max	Min	Max	
Read Cycle Time	TAVAV	TRC	70		85		100		ns
Address Access Time	TAVQV	TAA		70		85		100	ns
Chip Enable Access	TELQV	TACS		70		85		100	ns
Chip Enable to Output in Low Z (1)	TELQX	TCLZ	5		5		5		ns
Chip Disable to Output in High Z (1)	TEHQZ	TCHZ		30		35		40	ns
Output Hold from Address Change	TAVQX	TOH	3		3		3		ns
Output Enable to Output Valid	TGLQV	TOE		40		45		50	ns
Output Enable to Output in Low Z (1)	TGLQX	TOLZ	0		0		0		ns
Output Disable to Output in High Z(1)	TGHQZ	TOHZ		30		35		40	ns

Note 1: Parameter guaranteed, but not tested.



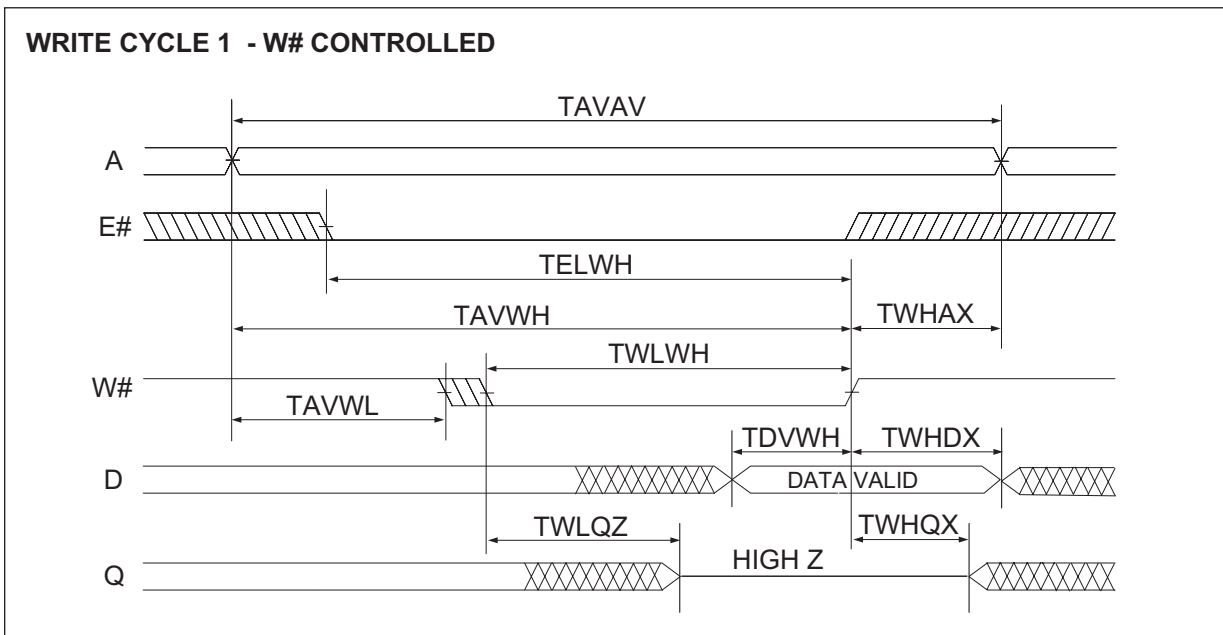
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AC CHARACTERISTICS WRITE CYCLE

Parameter	Symbol		70ns		85ns		100ns		Units
	JEDEC	Alt.	Min	Max	Min	Max	Min	Max	
Write Cycle Time	TAVAV	TWC	70		85		100		ns
Chip Enable to End of Write	TELWH	TCW	65		70		80		ns
	TELEH	TCW	65		70		80		ns
Address Setup Time	TAVWL	TAS	0		0		0		ns
	TAVEL	TAS	0		0		0		ns
Address Valid to End of Write	TAVWH	TAW	65		70		80		ns
	TAVEH	TAW	65		70		80		ns
Write Pulse Width	TWLWH	TWP	65		70		80		ns
	TWLEH	TWP	65		70		80		ns
Write Recovery Time	TWHAX	TWR	0		0		0		ns
	TEHAX	TWR	0		0		0		ns
Data Hold Time	TWHDX	TDH	0		0		0		ns
	TEHDX	TDH	0		0		0		ns
Write to Output in High Z (1)	TWLQZ	TWHZ	0	30	0	35	0	40	ns
Data to Write Time	TDVWH	TDW	30		35		40		ns
	TDVEH	TDW	30		35		40		ns
Output Active from End of Write (1)	TWHQX	TWLZ	5		5		5		ns

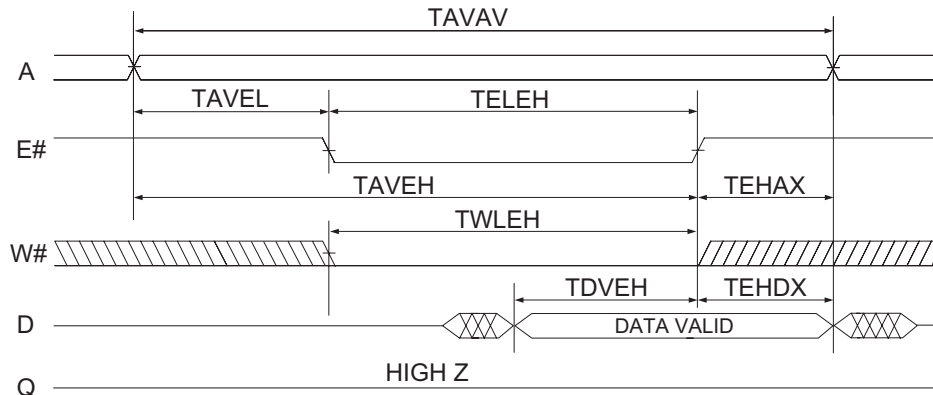
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WRITE CYCLE 2 - E# CONTROLLED

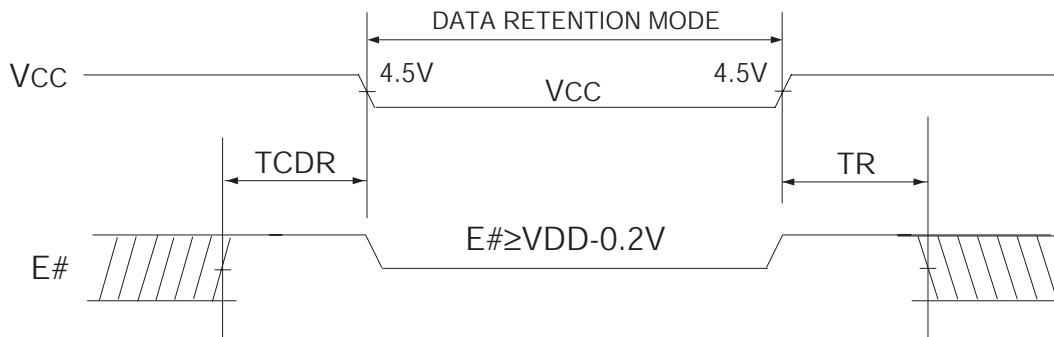


Characteristic	Sym	Test Conditions	Vcc	Min	Typ	Max		Unit
						70°C	85°C	
Data Retention Voltage	V _{CC}	V _{CC} = 0.2V		2	-	-	-	V
Data Retention Quiescent Current	I _{CCDR}	E# ≥ V _{CC} - 0.2V V _{IN} ≥ V _{CC} - 0.2V	2V	-	25	300	400	μA
			3V	-	50	450	550	μA
Chip Disable to Data Retention Time (1)	T _{CDR}	or V _{IN} ≤ 0.2V		0	-	-	-	ns
Operation Recovery Time (1)	TR			TAVAV*	-	-	-	ns

Note 1: Parameter guaranteed, but not tested.

* Read Cycle Time

DATA RETENTION E# CONTROLLED



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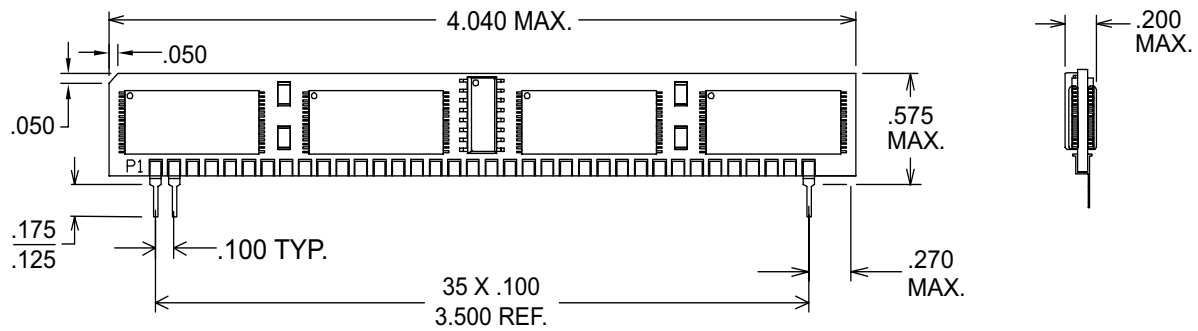
ORDERING INFORMATION

Standard Power	Low Power with Data Retention	Speed (ns)	Package No.
EDI8F81024C70BSC	EDI8F81024LP70BSC	70	62
EDI8F81024C85BSC	EDI8F81024LP85BSC	85	62
EDI8F81024C100BSC	EDI8F81024LP100BSC	100	62

Note: To order an Industrial grade product substitute the letter C in the Suffix with the letter I, e.g. EDI8F81024C70BSC becomes EDI8F81024C70BSI.

PACKAGE DESCRIPTION

PACKAGE NO. 62: 36 PIN SINGLE-IN-LINE PACKAGE



ALL DIMENSIONS ARE IN INCHES

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